January 2006

# FDN359BN N-Channel Logic Level PowerTrench<sup>™</sup> MOSFET

### **General Description**

SEMICONDUCTOR IM

This N-Channel Logic Level MOSFET is produced using Fairchild's Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

### Features

• 2.7 A, 30 V.  $R_{\text{DS(ON)}}$ = 0.046  $\Omega$  @ V<sub>GS</sub> = 10 V

 $R_{DS(ON)}$ = 0.060  $\Omega$  @ V<sub>GS</sub> = 4.5 V

- Very fast switching speed.
- Low gate charge (5nC typical)
- High performance version of industry standard SOT-23 package. Identical pin out to SOT-23 with 30% higher power handling capability.





## Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		30	V
V <sub>GSS</sub>	Gate-Source Voltage		±20	V
I <sub>D</sub>	Maximum Drain Current – Continuous	(Note 1a)	2.7	A
	– Pulsed		15	
P <sub>D</sub>	Maximum Power Dissipation	(Note 1a)	0.5	W
		(Note 1b)	0.46	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	e	-55 to +150	°C

# **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	250	°C/W		
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W		

# **Package Marking and Ordering Information**

Device Marking	Device	Reel Size	Tape width	Quantity
359B	FDN359BN	7"	8mm	3000 units

FDN359BN

Symbol	Parameter	Test C	Conditi	ons	Min	Тур	Мах	Units
Off Char	acteristics							
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ ,	I <sub>D</sub> = 2	50 µA	30			V
<u>ΔBV<sub>DSS</sub></u> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA,Re	eference	d to 25°C		21		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 V$ ,	$V_{GS} = 0$	V			1	μΑ
				$T_J = -55^{\circ}C$			10	μΑ
I <sub>GSS</sub>	Gate–Body Leakage	$V_{GS} = \pm 20 V$ ,	$V_{DS} = 0$	V			±100	nA
On Char	acteristics (Note 2)							
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS},$	I <sub>D</sub> = 2	50 µA	1	1.8	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA,Re	eference	d to 25°C		-4		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$V_{GS} = 10 V,$ $V_{GS} = 4.5 V,$ $V_{GS} = 10 V, I_D$	I <sub>D</sub> = 2 I <sub>D</sub> = 2 = 2.7 A,	.7 A .4 A T」= 125°C		0.026 0.032 0.033	0.046 0.060 0.075	Ω
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 10 V$ ,	V <sub>DS</sub> =	5 V	15			Α
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5V$ ,	I <sub>D</sub> = 2	7 A		11		S
Dynamic	Characteristics							
Ciss	Input Capacitance	$V_{DS} = 15 V$ , $V_{GS} = 0 V$ , f = 1.0 MHz		0 V,		485	650	pF
C <sub>oss</sub>	Output Capacitance					105	140	pF
C <sub>rss</sub>	Reverse Transfer Capacitance					65	100	pF
R <sub>G</sub>	Gate Resistance	f = 1.0 MHz				1.8		Ω
Switchin	g Characteristics (Note 2)							
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = 15V$ ,	I <sub>D</sub> = 1	A,		7	14	ns
t <sub>r</sub>	Turn–On Rise Time	$V_{GS} = 10 V$ ,	10 V, $R_{GEN} = 6 \Omega$		5	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time				20	35	ns	
t <sub>f</sub>	Turn-Off Fall Time					2	4	ns
Qg	Total Gate Charge	$V_{DS} = 15 V$ ,	I <sub>D</sub> = 2	7 A,		5	7	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 5 V$				1.3		nC
-	Gate-Drain Charge					1.8		nC

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Electric	Electrical Characteristics T <sub>A</sub> = 25°C unless otherwise noted							
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units		
Drain–Source Diode Characteristics and Maximum Ratings								
Is	Maximum Continuous Drain–Source Diode Forward Current				0.42	А		
$V_{SD}$	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_S = 0.42 A$ (Note 2)		0.7	1.2	V		
trr	Diode Reverse Recovery Time	IF = 2.7A, diF/dt = 100 A/µs		12	20	ns		
Qrr	Diode Reverse Recovery Charge			3	5	nC		

otes:

 R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

> î No



 a) 250°C/W when mounted on a 0.02 in<sup>2</sup> pad of 2 oz. copper. b) 270°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width  $\leq 300~\mu\text{s},$  Duty Cycle  $\leq 2.0\%$ 

FDN359BN Rev A(W)



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